

General Description

The MDS3753E uses advanced Magnachip's MOSFET Technology to provide low on-state resistance, high switching performance and excellent reliability

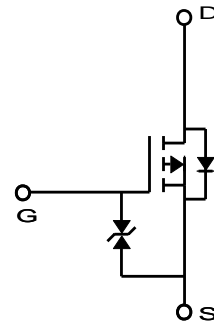
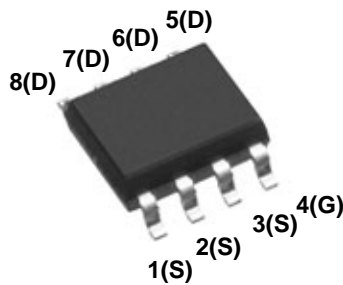
Low $R_{DS(ON)}$ and low gate charge operation offer superior benefit in the application.

Features

- $V_{DS} = -40V$
- $I_D = -7.1A$ @ $V_{GS} = 10V$
- $R_{DS(ON)}$
 $<30m\Omega$ @ $V_{GS} = -10V$
 $<37m\Omega$ @ $V_{GS} = -4.5V$

Applications

- Inverters
- General purpose applications



Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Characteristics	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	-40	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current (Note 1)	I_D	-7.1	A
Pulsed Drain Current	I_{DM}	-50	A
Power Dissipation	P_D	2.5	W
Single Pulse Avalanche Energy (Note 2)	E_{AS}	98	mJ
Junction and Storage Temperature Range	T_J, T_{stg}	-55~150	$^\circ C$

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	50	$^\circ C/W$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	25	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDS3753EURH	-55~150°C	SO-8	Tape & Reel	Halogen Free

Electrical Characteristics (T_J =25°C unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = -250μA, V _{GS} = 0V	-40	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.0	-1.8	-3.0	
Drain Cut-Off Current	I _{DSS}	V _{DS} = -40V, V _{GS} = 0V	-	-	-10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±16V, V _{DS} = 0V	-	-	±10	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = -10V, I _D = -3.3A	-	20	30	mΩ
		V _{GS} = -4.5V, I _D = -3.3A	-	27	37	
Forward Transconductance	g _{FS}	V _{DS} = -10V, I _D = -3.3A		14	-	S
Dynamic Characteristics						
Total Gate Charge	Q _g	V _{DD} = -32V, I _D = -4.7A, V _{GS} = -10V	-	32.7	-	nC
Gate-Source Charge	Q _{gs}		-	4.1	-	
Gate-Drain Charge	Q _{gd}		-	7.4	-	
Input Capacitance	C _{ISS}	V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz	-	1423	-	pF
Reverse Transfer Capacitance	C _{rSS}		-	129	-	
Output Capacitance	C _{OSS}		-	221	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = -10V, V _{DD} = -20V, I _D = -3.3A R _{GEN} = 4.7Ω	-	14.7	-	ns
Turn-On Rise Time	t _r		-	7.1	-	
Turn-Off Delay Time	t _{d(off)}		-	44.2	-	
Turn-Off Fall Time	t _f		-	9.0	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = -4.7A, V _{GS} = 0V	-	0.81	1.2	V
Reverse Recovery Time	t _{rr}	I _S = -4.7A, di/dt=100A/us	-	34	-	ns
Reverse Recovery Charge	Q _{rr}		-	36.5	-	nC

Note :

1. Surface mounted FR4 board with 2oz. Copper.
2. Starting T_J=25°C, L=1mH, I_{AS}=-14A V_{DD}=-20V, V_{GS}=-10V

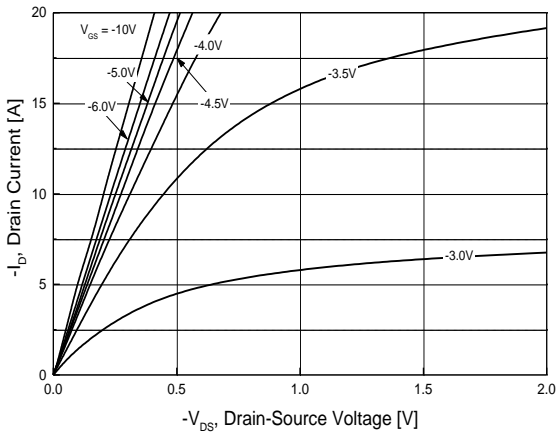


Fig.1 On-Region Characteristics

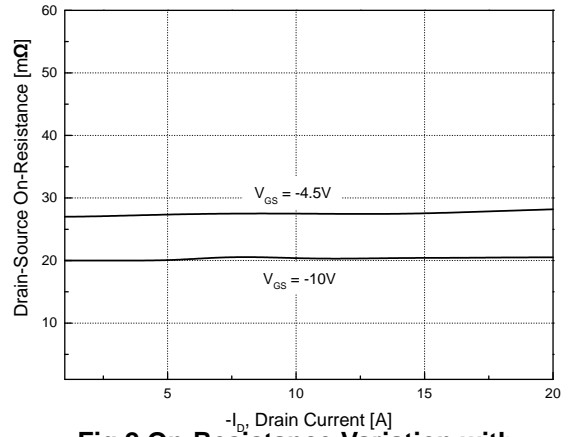


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

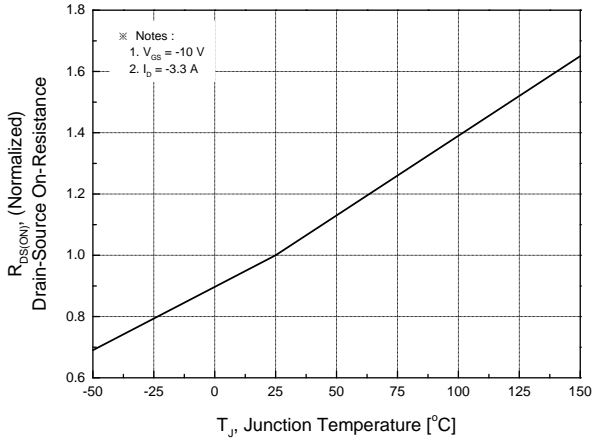


Fig.3 On-Resistance Variation with Junction Temperature

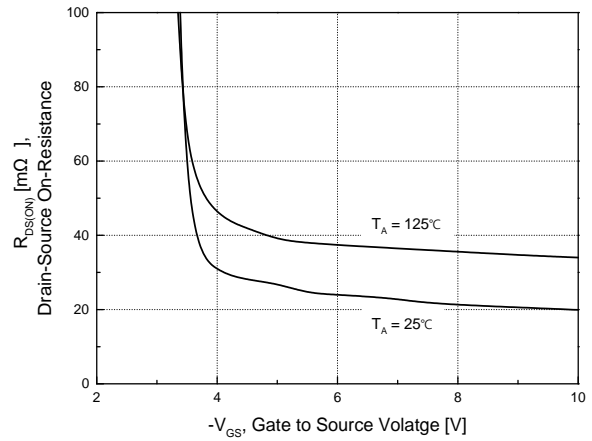


Fig.4 On-Resistance Variation with Gate to Source Voltage

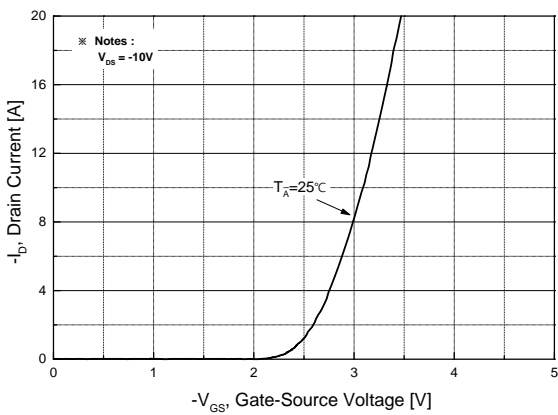


Fig.5 Transfer Characteristics

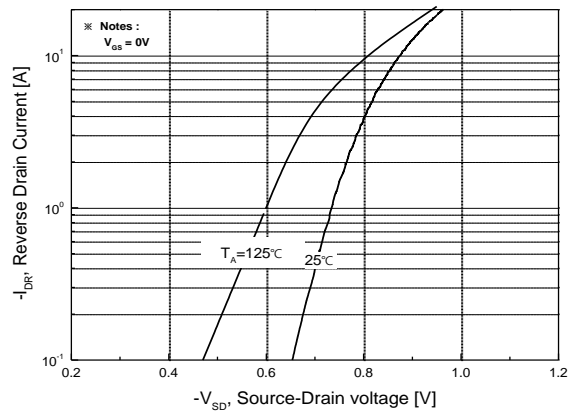
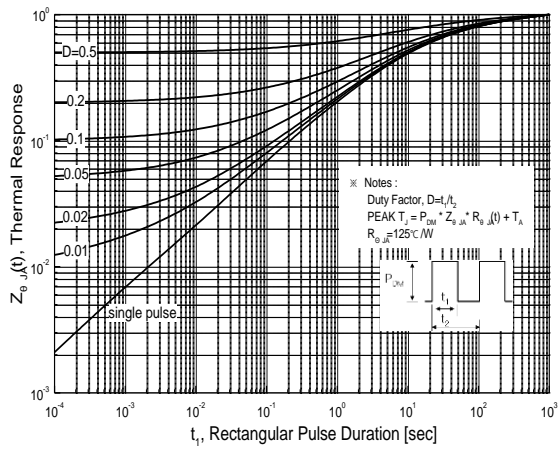
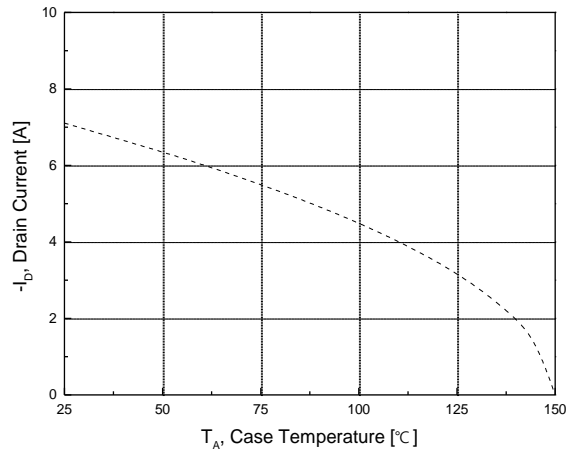
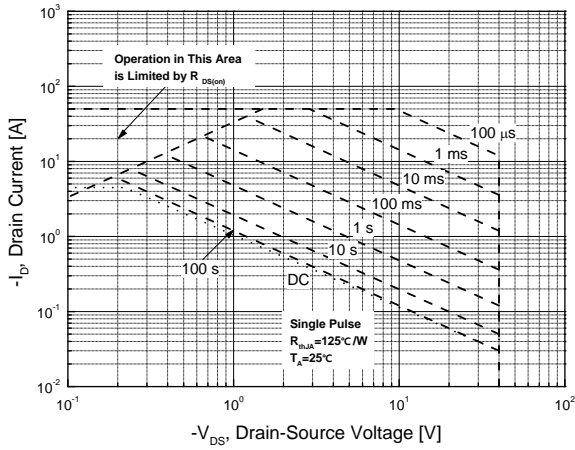
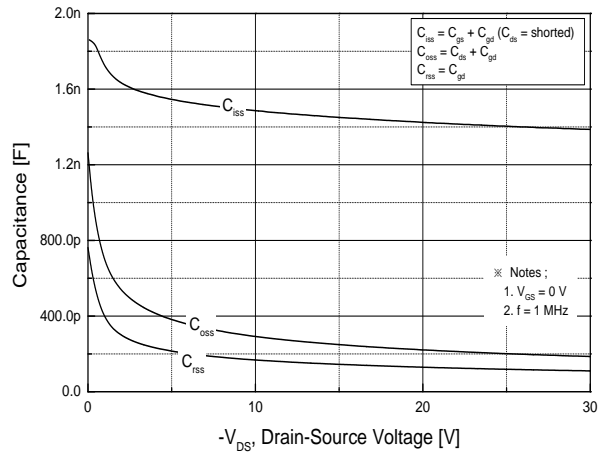
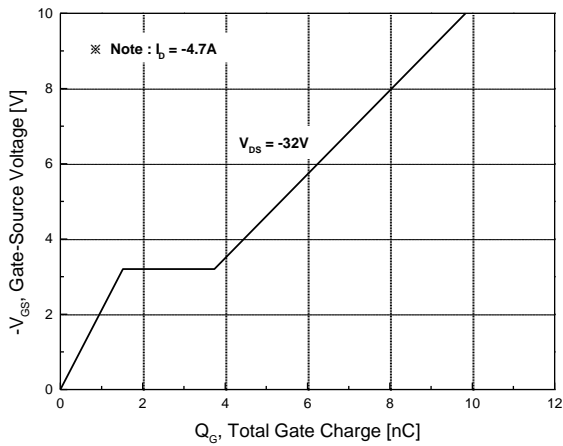


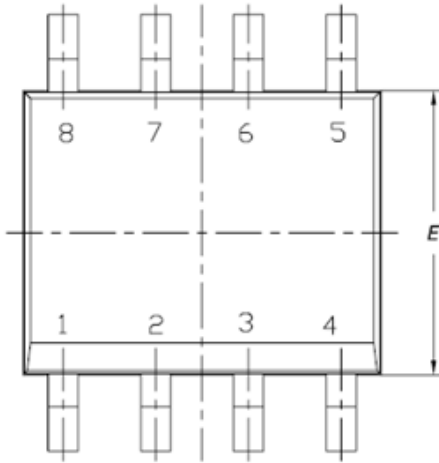
Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature



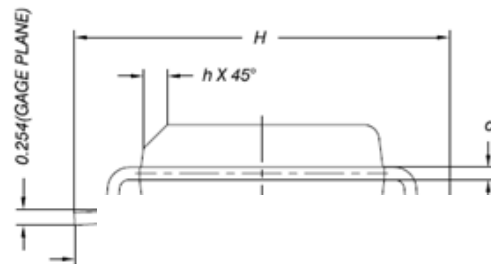
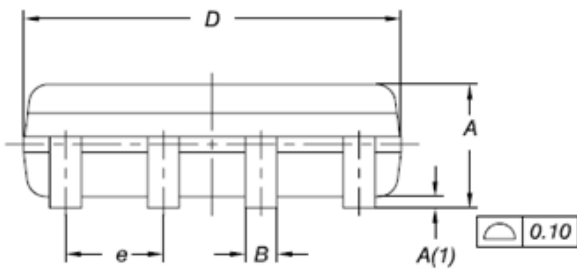
Physical Dimensions

8 Leads, SOIC

Dimensions are in millimeters unless otherwise specified




Symbol	Min	Nom	Max
A	-	-	1.75
A(1)	0.10	-	0.25
B	0.31	-	0.51
C	0.10	-	0.25
D	4.9 BSC		
E	3.9 BSC		
e	1.27 BSC		
H	6.0 BSC		
L	0.40	-	1.27
a	0	-	8
h	0.250	-	0.500
L2(Gage plane)	0.25 BSC		



Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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